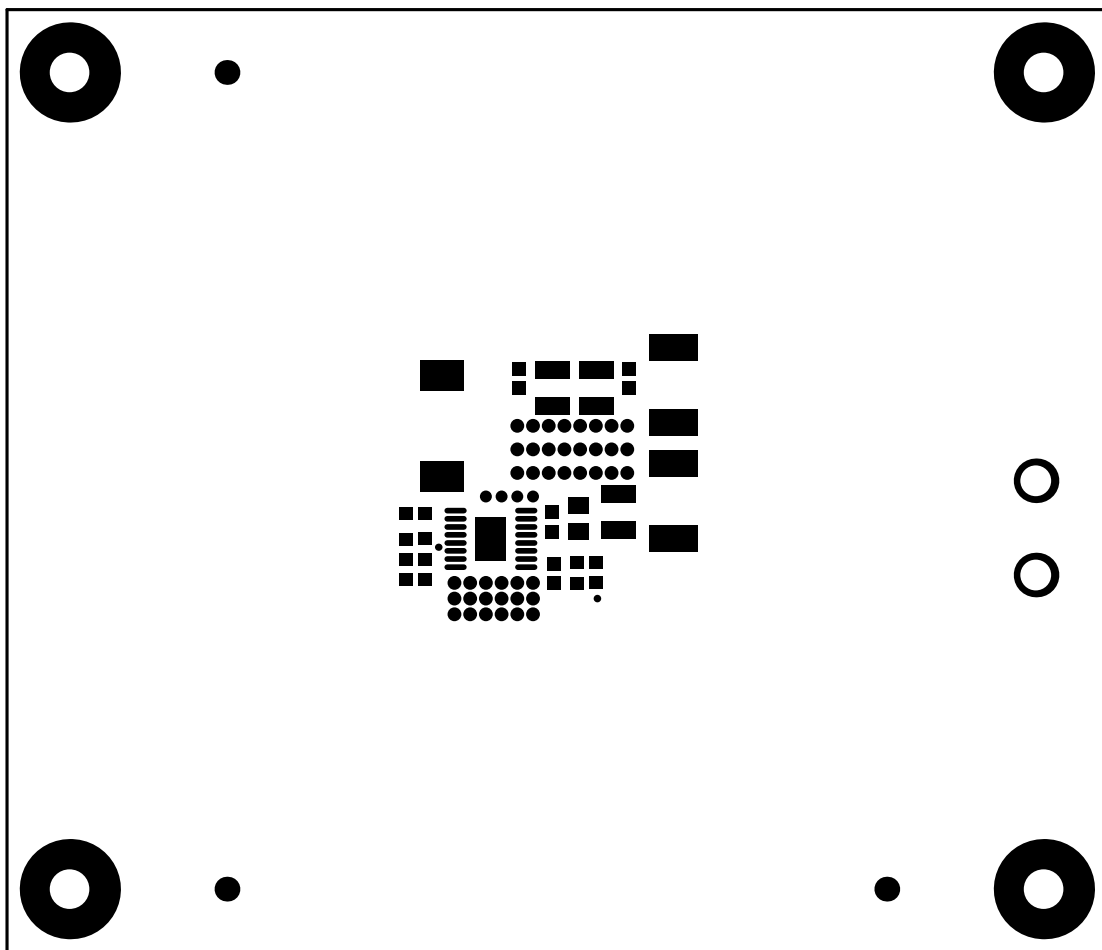
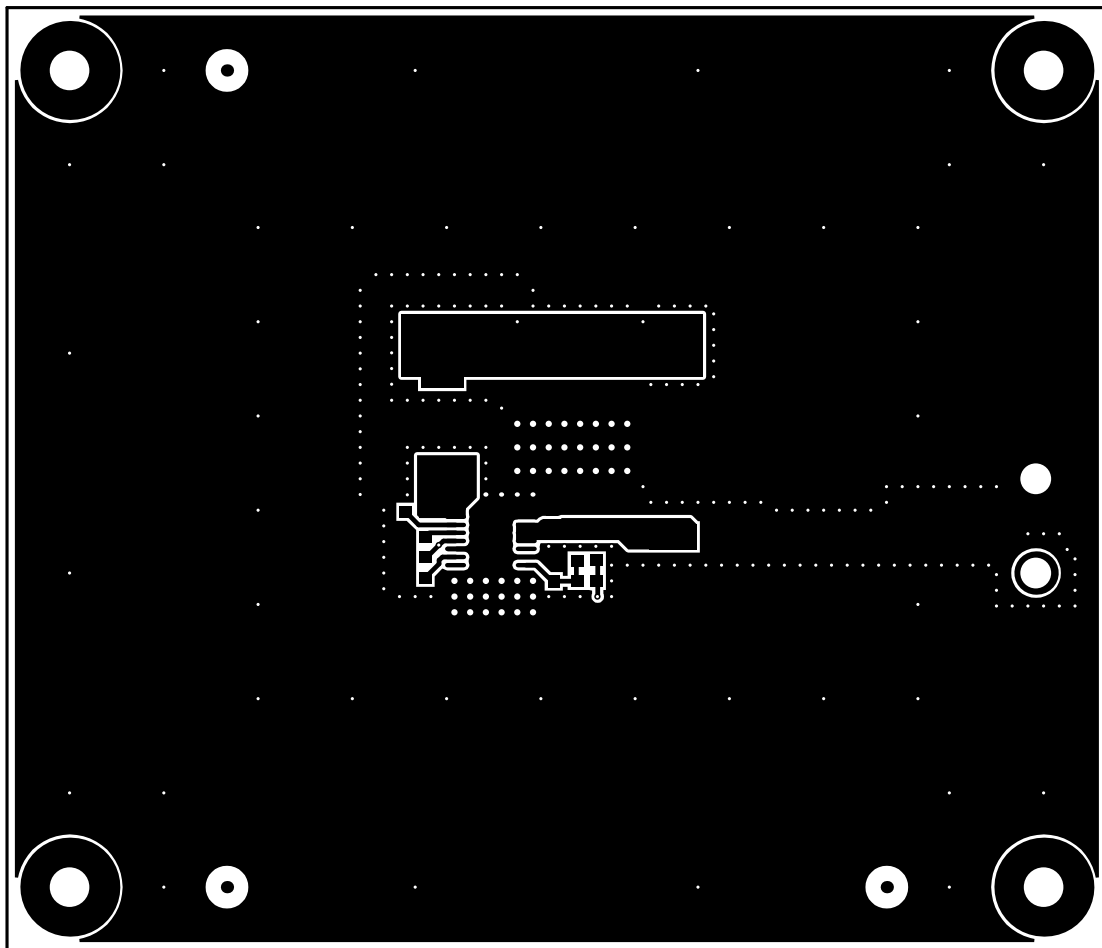


PMP10735 E1

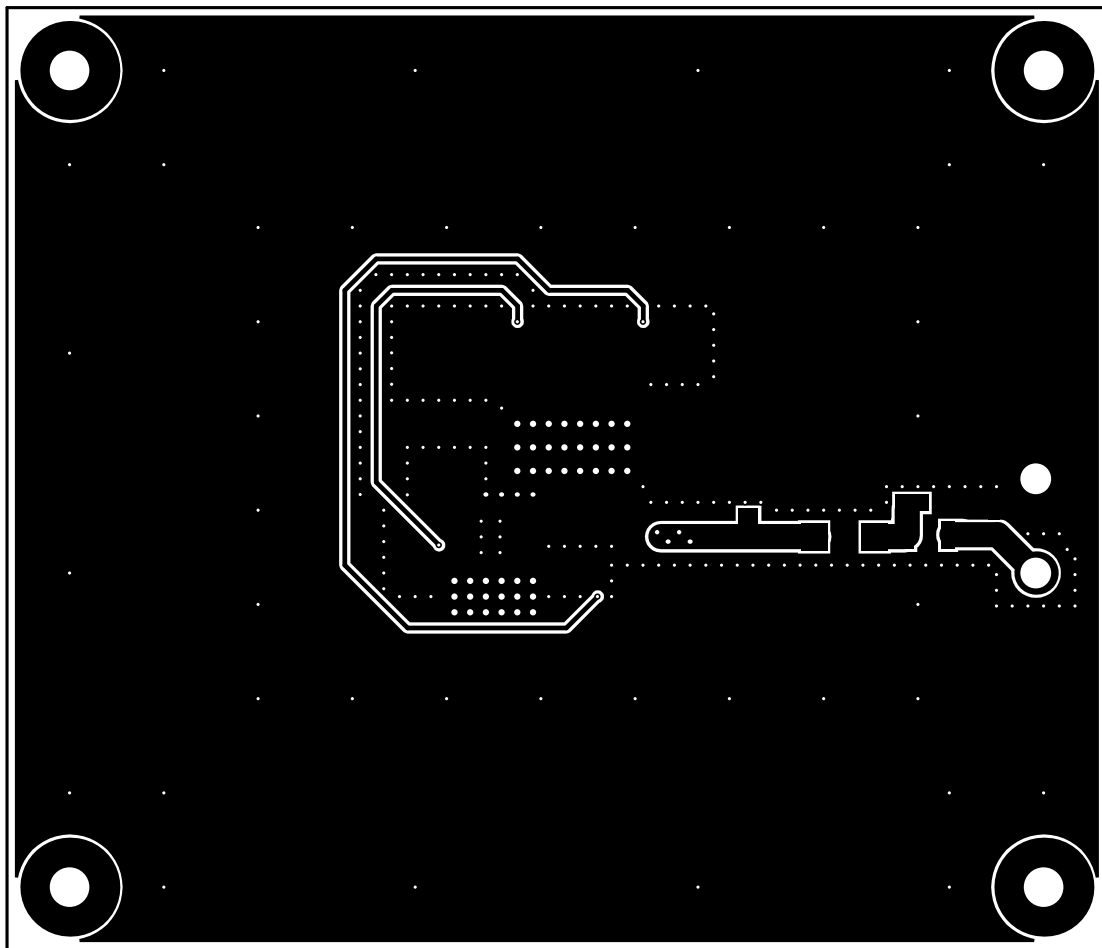
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10735	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP10735		
PLOT NAME = Top Overlay	GENERATED : 9/15/2015	5:09:21 PM	TEXAS INSTRUMENTS



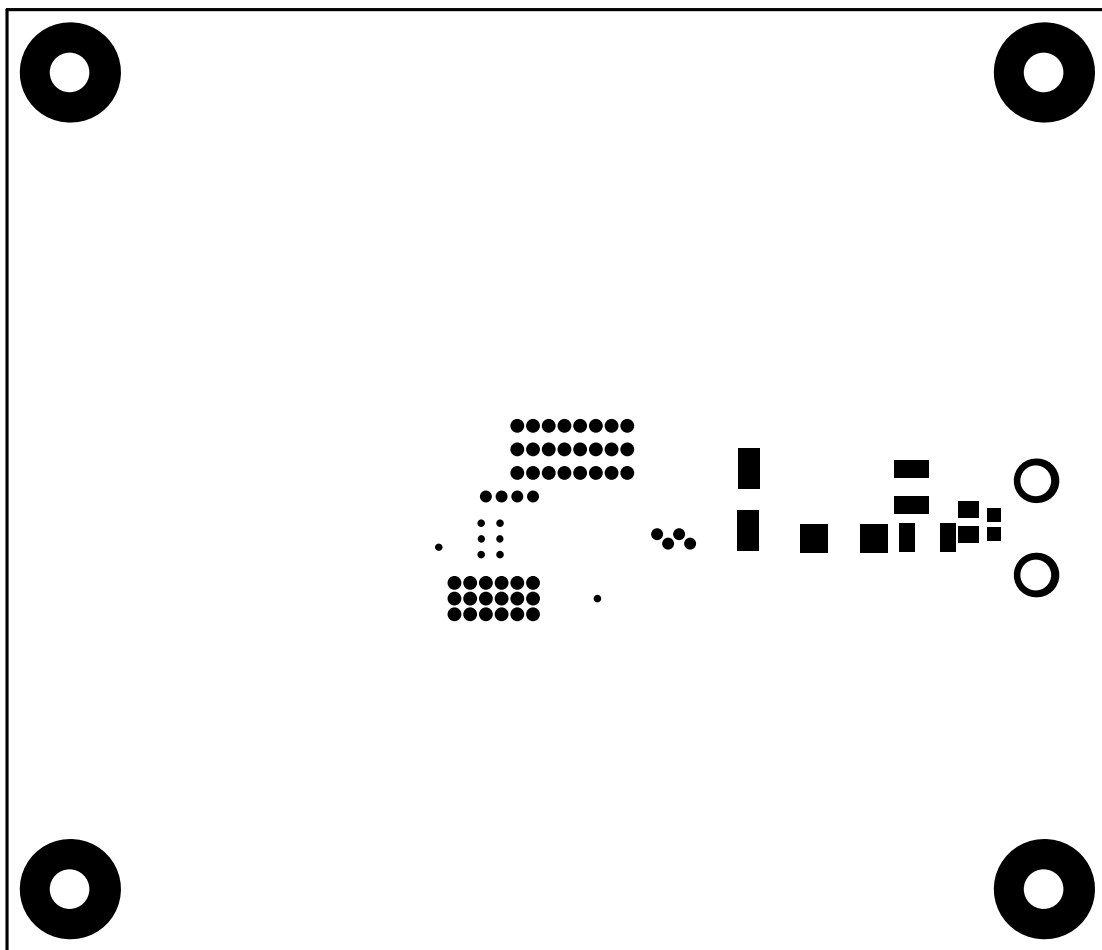
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10735	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: PMP10735		
PLOT NAME = Top Solder Mask	GENERATED : 9/15/2015 5:09:22 PM	TEXAS INSTRUMENTS	



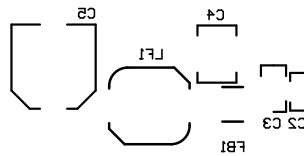
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10735	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP10735		
PLOT NAME = Top Layer	GENERATED : 9/15/2015	5:09:23 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10735	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP10735		
PLOT NAME = Bottom Layer	GENERATED : 9/15/2015	5:09:24 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10735	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: PMP10735		
PLOT NAME = Bottom Solder Mask	GENERATED : 9/15/2015	5:09:26 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE

BOARD #: PMP10735

REV: E1

SUN REV: Not In VersionControl

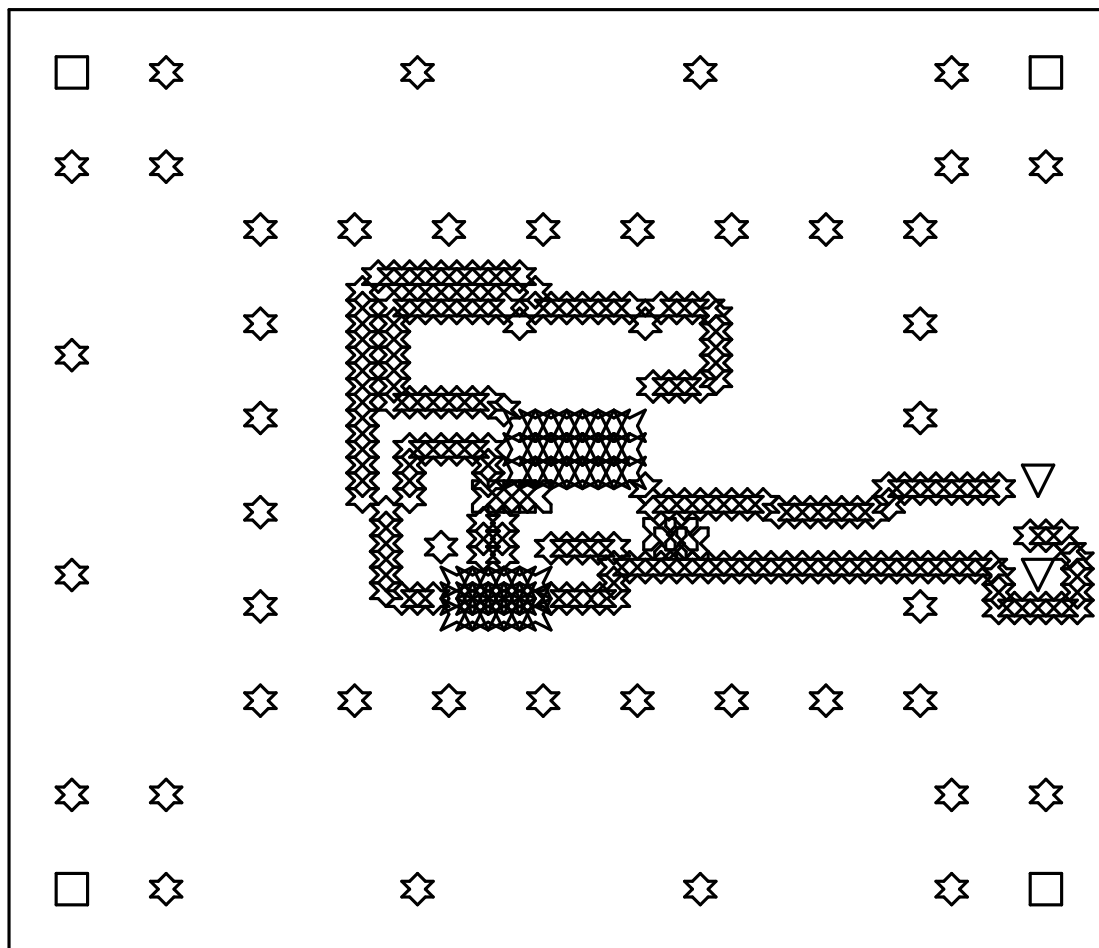
LAYER NAME = Bottom Overlay

TID #: PMP10735

PLOT NAME = Bottom Overlay

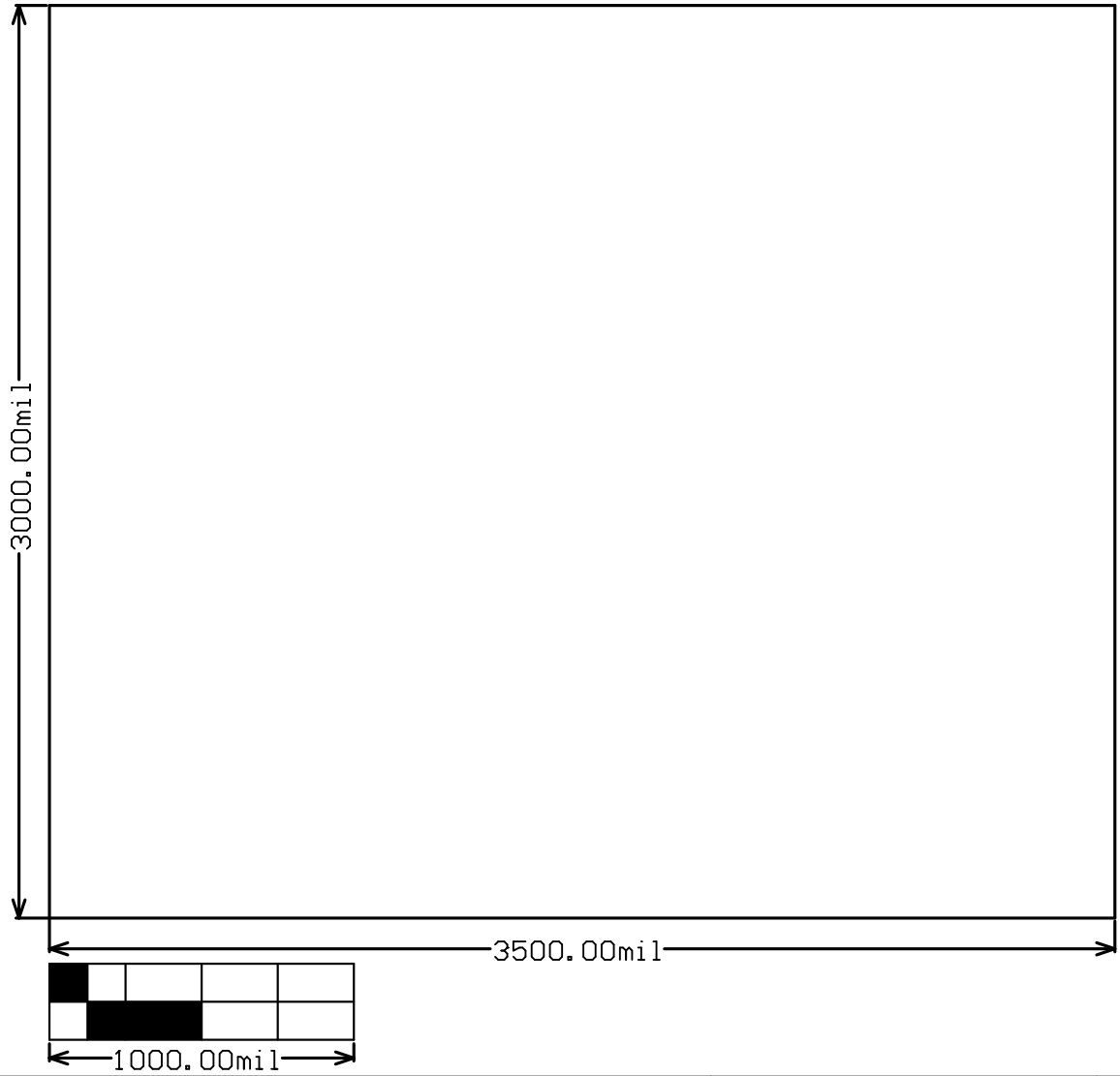
GENERATED : 9/15/2015 5:09:27 PM

TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
✳	212	10.00mil (0.254mm)	PTH	Round
⊗	8	15.00mil (0.381mm)	PTH	Round
⊗	42	20.00mil (0.508mm)	PTH	Round
▽	2	98.43mil (2.500mm)	PTH	Round
□	4	125.98mil (3.200mm)	PTH	Round
	268 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10735	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP10735		
PLOT NAME = Drill Drawing	GENERATED : 9/15/2015	5:09:28 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10735	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP10735		
PLOT NAME = Board Dimensions	GENERATED : 9/15/2015	5:09:29 PM	TEXAS INSTRUMENTS



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